

# **System Lens Drivers**

# $\mu$ -step System Lens Driver for Digital Still Cameras

# BU24032GW

#### General Description

BU24032GW is a system Lens Driver that uses  $\mu$ -step driving to make the configuration of the sophisticated, high precision and low noise lens driver system possible. This IC has a built-in driver for both DC motor and voice coil motor and a  $\mu$ -step controller that decreases CPU power. Therefore, multifunctional lens can be applied.

#### Features

- Built-in 6 channels Driver block
  1ch-5ch: Voltage control type H-bridge (Adaptable to STM 1systems)
   6ch: Current control type H-bridge
- Built-in 2 channels PI driving circuit
- Built-in 3 channels Waveforming circuit
- Built-in FLL digital servo circuit
- Built-in PLL circuit

#### Applications

Digital still cameras

#### Typical Application Circuit

#### •Key Specifications

- Digital Power Supply Voltage:
- Driver Power Supply Voltage:
- Output Current (1ch-5ch):
- Input Clock Frequency:
- FET ON Resistance (1ch-5ch):
- FET ON Resistance (6ch):
- Operating Temperature Range:

#### 

UCSP75M2

2.50mm x 2.50mm x 0.85mm



OProduct structure : Silicon monolithic integrated circuit OThis product is not designed for protection against radioactive rays



2.7V to 3.6V

2.7V to 5.5V

2.0Ω(Typ)

1.0Ω(Typ)

±500mA(Max)

1MHz to 28MHz

-20°C to +85°C

# Pin Configuration

(Bottom view)



#### Pin Description

Land Matrix No.	Pin Name	Power Supply	Function	Land Matrix No.	Pin Name	Power Supply	Function
B3	DVDD	-	Digital power supply	A6	MGND126	-	1ch, 2ch, 6ch Driver ground
C2	DVSS	-	ground	A3	OUT1A	MVCC12	1ch Driver A output
B2	FCLK	DVDD	FCLK logic input	A2	OUT1B	MVCC12	1ch Driver B output
E2	CSB	DVDD	CSB logic input	A4	OUT2A	MVCC12	2ch Driver A output
D2	SCLK	DVDD	SCLK logic input	A5	OUT2B	MVCC12	2ch Driver B output
B1	SDATA	DVDD	SDATA logic input	E1	MVCC345	-	3ch, 4ch, 5ch Driver power supply
B4	STATE/IN6	DVDD	STATE/IN6 logic input, output	F4	MGND345	-	3ch, 4ch, 5ch Driver ground
F1	PIOUT1	DVDD	PI driving output 1	F2	OUT3A	MVCC345	3ch Driver A output
B6	PIOUT2	VDDAMP	PI driving output 2	D1	OUT3B	MVCC345	3ch Driver B output
C5	SI1	DVDD	Waveforming input1	F5	OUT4A	MVCC345	4ch Driver A output
D5	SO1	DVDD	Waveforming output1	F3	OUT4B/5B	MVCC345	4ch/5ch Driver B output
B5	SI2	DVDD	Waveforming input2	C1	OUT5A	MVCC345	5ch Driver A output
E5	SO2	DVDD	Waveforming output2	F6	VDDAMP	-	6ch Power supply of current driver control
E4	SI3	DVDD	Waveforming input3	D6	RNF6	-	6ch Driver power supply
E3	SO3/SOUT	DVDD	Waveforming output3 / SOUT logic output	E6	OUT6A	RNF6	6ch Driver A output
A1	MVCC12	-	1ch, 2ch Driver power supply	C6	OUT6B	RNF6	6ch Driver B output

# Block Diagram



# Description of Blocks

<u>Stepping Motor Driver (1ch, 2ch Driver)</u> Built-in stepping motor driver of PWM driving type. 1 stepping motor can be driven.

Built-in voltage feedback circuit of D-class type.

# (1) Control

It corresponds to both Clock IN and Autonomous control.

#### ( i )Clock IN Control

Set the registers for the stepping motor control.

The stepping motor is rotated and synchronized with the input clock in the STATE pin.

It is possible to select the mode of stepping motor control from  $\mu$ -step, 1-2 phase excitation, 2 phase excitation and the number of edge for electrical angle cycle from 4, 8, 32, 64, 128, 256, 512 or 1024.



#### (ii) Autonomous Control

The stepping motor is rotated by setting the registers for the stepping motor control.

The state of rotation command (executing:1, finished:0), Cache register and motor position are the output from the serial output (SOUT pin). Also, the signal (MO output) which is synchronized with the motor rotation is the output from STATE pin.

It is possible to select the mode of stepping motor control from  $\mu$ -step (1024 portion), 1-2 phase excitation and 2 phase excitation.

Built-in Cache registers.

Cache registers enable the setting of subsequent process while the motor is in operation. Through these registers, operations are done continuously.



# Description of Blocks

Voltage Driver (3ch-5ch Driver) Built-in voltage driver of PWM driving type. 4ch/5ch driver is the exclusive driver. Built-in digital FLL speed control logic for 5ch driver.

# (1)Control

( i )Register Control

■ 3ch Driver, 4ch Driver, 5ch Driver (at speed control = OFF)

The PWM drive is executed by the PWM duty ratio, the PWM direction and the PWM ON/OFF which are controlled by the register settings.



# ■5ch Driver (at speed control = ON)

The speed control drive is executed by the target speed value, the direction, the coefficient value of PI filter and the turning ON/OFF which are controlled by the register settings.

The motor speed is adjusted by comparing the target speed with the motor speed detected at the signal of photo-interrupter.



# Description of Blocks

# Current Driver (6ch Driver)

#### Built-in constant current driver.

The voltage of RNF pin and the external resistor (RRNF) determine the amount of output current. The internal high-precision amplifier (CMOS gate input) is used for the constant current control. If any resistance component exists in the wirings of RNF pin and the external resistor (RRNF), the precision can be reduced. To avoid this, pay utmost attention to the wirings.

#### (1) Control

#### ( i )Register Control

The constant current drive is executed by the output current value, the current direction and the current ON/OFF which are controlled by the register settings.



#### (ii) External Pin Control

The constant current drive is executed by the output current value and current direction which are controlled by the register setting. Constant current driving ON/OFF is controlled by IN6 pin.



# ●Absolute Maximum Ratings (Ta=25°C)

Parameter Symb		Limit	Unit	Remark
	DVDD	-0.3 to +4.5	V	
Power Supply Voltage	MVCC	-0.3 to +7.0	V	MVCC12, MVCC345, VDDAMP
Input Voltage	VIN	-0.3 to supply voltage+0.3	V	
Input / output Ourrent *1		±500	mA	MVCC12, MVCC345, RNF6
input / output Current	IIIN	+50	mA	by PIOUT pin
Storage Temperature Range	TSTG	-55 to +125	°C	
Operating Temperature Range	TOPE	-20 to +85	°C	
Permissible Dissipation *2	PD	800	mW	

\*1 Must not exceed PD.

To use at a temperature higher than Ta=25 °C, derate 8mW per 1 °C (At mounting 50mm x 58mm x 1.75mm glass epoxy board.) \*2

# Recommended Operating Rating (Ta=25°C)

Parameter	Symbol	Limit	Unit	Remark
Digital Power Supply Voltage	DVDD	2.7 to 3.6	V	DVDD≦MVCC
Driver Power Supply Voltage	MVCC	2.7 to 5.5	V	MVCC12, MVCC345, VDDAMP
Clock Operating Frequency	FCLK	1 to 28	MHz	Reference clock

# •Electrical Characteristics

Parameter		O mark al	Limit			1.1 14	Conditions
		Symbol	MIN	TYP	MAX	Unit	Conditions
<current consum<="" td=""><td>ption&gt;</td><td>J. J.</td><td></td><td>1</td><td>L</td><td></td><td></td></current>	ption>	J. J.		1	L		
Quiescence (DVDD)		ISSD	-	20	50	μA	CMD_RS=0
	(MVCC)	ISSM	-	0	10	μA	
Operation	(DVDD)	IDDD	-	4	8	mA	CMD_RS=STB=CLK_EN=1 FCLK=24MHz CLK_DIV setting : 0h No load
<logic block=""></logic>							
Low-level Input Ve	oltage	VIL	DVSS	-	0.3DVDD	V	
High-level Input V	oltage	VIH	0.7DVDD	-	DVDD	V	
Low-level Input C	urrent	IIL	0	-	10	μA	VIL=DVSS
High-level Input C	Current	IIH	0	-	10	μA	VIH=DVDD
Low-level Output	Voltage	VOL	DVSS	-	0.2DVDD	V	IOL=1.0mA
High-level Output	Voltage	VOH	0.8DVDD	-	DVDD	V	IOH=1.0mA
<pi circui<="" driving="" td=""><td>t&gt;</td><td></td><td></td><td></td><td></td><td></td><td></td></pi>	t>						
Output Voltage		PIVO	-	0.15	0.5	V	IIH=30mA
<waveforming ci<="" td=""><td>rcuit&gt;</td><td></td><td></td><td></td><td></td><td></td><td></td></waveforming>	rcuit>						
High-level Thresh	High-level Threshold Voltage			-	1.9	V	DVDD=3.25V
Low-level Thresh	old Voltage	VthL	0.9	-	-	V	DVDD=3.25V
Hysteresis Width		Vhys	0.2	-	0.6	V	DVDD=3.25V
<voltage b<="" driver="" td=""><td>lock 1ch-5ch&gt;</td><td>•</td><td></td><td></td><td></td><td></td><td></td></voltage>	lock 1ch-5ch>	•					
ON-resistance	ON-resistance			2.0	2.5	Ω	IO=±100mA (the sum of high and low sides)
OFF-leak Current	OFF-leak Current		-10	0	+10	μA	Output Hiz setting
Average Voltage Abetween different	Vdiff	-5	-	+5	%	STM driver(1ch,2ch) Vdiff setting : 2Bh	
<current bl<="" driver="" td=""><td>ock 6ch&gt;</td><td></td><td></td><td></td><td></td><td></td><td></td></current>	ock 6ch>						
ON-resistance		Ron	-	1.0	1.5	Ω	IO=±100mA (the sum of high and low sides)
OFF-leak Current		IOZ	-10	0	+10	μA	Output Hiz setting
Output Current	Ю	193	200	207	mA	DAC setting : 80h RRNF=1Ω	

# Typical Performance Curves



# Typical Performance Curves



# Typical Performance Curves



# Timing Chart

Parameter	Symbol	Specification
SCLK input cycle	tSCLK	More than 100 nsec
SCLK L-level input time	tSCLKL	More than 50 nsec
SCLK H-level input time	tSCLKH	More than 50 nsec
SDATA setup time	tsSDATA	More than 50 nsec
SDATA hold time	thSDATA	More than 50 nsec
CSB H-level input time	tCSBH	More than 380 nsec
CSB setup time	tsCSB	More than 50 nsec
CSB hold time	thCSB	More than 50 nsec
FCLK input cycle	tFCLK	More than 36 nsec
FCLK L-level input time	tFCLKL	More than 18 nsec
FCLK H-level input time	tFCLKH	More than 18 nsec



(note1) FCLK is asynchronous with SCLK. (note2) Duty of FCLK, SCLK are free.

#### Serial interface

Control commands are framed by a 16-bit serial input (MSB first) and are sent through CSB, SCLK, and SDATA pins. The 4 higher-order bits specify addresses, while the remaining 12 bits specify data. Data of every bit is sent through SDATA pin, which is retrieved during the rising edge of SCLK. Data becomes valid when CSB is Low and is registered during the rising edge of CSB. Furthermore, the interface will be synchronized with the falling edges of SCLK to output the SOUT data of the 12 bits.



#### <Register map>

Ac	ddre	ss[3	:0]		Data[11:0]										
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	A_Mo	de[1:0]		A_SEL[2:0	]			A_differen	t_output_v	oltage[6:0]		
				0	0	0	0			A_Cyc	:le[5:0]			0	0
				0	0	1	0				A_Cyc	le[13:6]			
0	0	0	1	0	1	0	0	0	0	0	0		A_Start_	POS[3:0]	
				0	1	1	0	A_BEXC	0	0	A_BSL	A_AEXC	0	0	A_ASL
				1	1	1	0	0	0	A_PO	S[1:0]	0	0	A_PS	A_Stop
0	0	1	0	A_EN	A_RT							A_Pul	se[9:0]		
0	0	1	1	A_ACT	A_BUSY	L	L	L	L	L	L	L	L	L	L
0	1	1	1		A_Posit	ion[9:6]		L	L	L	L	L	L	L	L
1	0	1	1	0	0	0	0	0	0	Edge	0	0	0	0	A_CTL
	U		'	0	0	1	0	0	0	SO3_SEL	45_SEL	0	0	0	EXT_CTL
1	1	0	0	0	0	Chopp	ing[1:0]	CacheM	0	0	CLK_EN	N CLK_DIV[3:0]			
				0	0	0	0	0	0	0	0	0	0	PI_CTL2	PI_CTL1
				0	0	1	0	0	0	0	0	3_State_	CTL[1:0]	3_CH0	DP[1:0]
				0	1	0	0	0			3_F	WM_Duty[	6:0]		
				0	1	1	0	0	0	0	0	4_State_	CTL[1:0]	4_CH0	OP[1:0]
		_		0	1	1	1	0	4_PWM_Duty[6:0]						
1	1	0	1	1	0	0	0	5_DET _SEL	0	0	5_SPEN	5_State_	CTL[1:0]	5_CHC	OP[1:0]
				1	0	0	1	0	0 5_PWM_Duty[6:0]						
				1	0	1	0	5_TARSP[7:0]							
				1	0	1	1	0	5_PSP[2:0] 0 5_ISP[2:0]						
				1	1	1	0	0	0	0 0 0 5_SPC_Limit[3:0]					
				0	0	0	0				6_IOL	JT[7:0]			
1	1	1	0	0	1	0	0	0	0	0	0	0	0	6_State_	_CTL[1:0]
1		1	0	1	0	1	0	0	0	0	0	0	HYS3	HYS2	HYS1
				1	1	0	0	0	0	0	STB	0	0	STM_RS	CMD_RS
Ade	Addresses other ban those above Setting prohibited														

(Note1) The notation A is defined as Ach: 1ch and 2ch driver.

(Note2) After reset (Power ON reset), the initial condition is saved in all registers.

(Note3) The addresses 4'b0011, and 4'b0111 have data (ACT, BUSY, Position [9:6]), which are internal register values and output from SOUT pin.
 (Note4) For Mode, different output voltage, Cycle, EN, and RT registers, data that are written before the access to the Pulse register becomes valid and determines the rising edge of CSB after the access to the Pulse register.

(The Mode, different output voltage, Cycle, EN, RT, and Pulse registers contain Cache registers. Any registers other than those do not contain Cache registers.)

# Application Example



# ●I/O Equivalence Circuit

Pin	Equivalent Circuit Diagram	Pin	Equivalent Circuit Diagram
FCLK CSB SCLK SDATA		STATE/IN6	DVDD DVDD
SI1 SI2 SI3		SO1 SO2 SO3/SOUT	
PIOUT1		PIOUT2	
OUT1A OUT1B OUT2A OUT2B		OUT3A OUT3B OUT4A OUT5A OUT4B/5B	
OUT6A OUT6B			

# Operational Notes

1) Absolute maximum ratings

If applied voltage, operating temperature range, or other absolute maximum ratings are exceeded, the LSI may be damaged. Do not apply voltages or temperatures that exceed the absolute maximum ratings. If you expect that any voltage or temperature could be exceeding the absolute maximum ratings, take physical safety measures such as fuses to prevent any conditions exceeding the absolute maximum ratings from being applied to the LSI.

2) GND potential

The voltage of the ground pin must be the lowest voltage of all pins of the IC at all operating conditions. Ensure that no pins are at a voltage below the ground pin at any time, even during transient condition.

3) Thermal design

Use a thermal design that allows for a sufficient margin by taking into account the permissible power dissipation (PD) in actual operating conditions.

- 4) Short circuit between pins and malfunctions Ensure that when mounting the IC on the PCB the direction and position are correct. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.
- 5) Operation in strong magnetic field Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.
- 6) Power ON sequence To turn ON the DVDD, be sure to reset at CMD\_RS register.
- 7) Thermal shutdown

The IC incorporates a built-in thermal shutdown circuit, which is designed to turn off the IC when the internal temperature of the IC reaches a specified value. It is not designed to protect the IC from damage or guarantee its operation. Do not continue to operate the IC after this function is activated. Do not use the IC in conditions where this function will always be activated.

8) PI drive circuit

The output voltage of PIOUT1 should not exceed the voltage of the power supply voltage DVDD. The output voltage of PIOUT2 should not exceed the voltage of the power supply voltage VDDAMP.

# Ordering Information



Marking Diagram



# Physical Dimension Tape and Reel Information



the tape on the right hand)

Direction of feed

1pin

Reel

# Revision History

Date	Revision	Changes
26.Sep.2012	001	New Release
18.Apr.2013	002	Update some English words, sentences, descriptions, grammar and formatting.

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- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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# BU24032GW - Web Page

**Distribution Inventory** 

Part Number	BU24032GW
Package	UCSP75M2
Unit Quantity	3000
Minimum Package Quantity	3000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes